# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# Very Low Forward Voltage Trench-based Schottky Rectifier

### Exceptionally Low $V_F = 0.50$ V at $I_F = 5$ A

#### Features

- Fine Lithography Trench–based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- Pb-Free and Halide-Free Packages are Available

#### **Typical Applications**

- Switching Power Supplies including Notebook / Netbook Adapters, ATX and Flat Panel Display
- High Frequency and DC–DC Converters
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation

#### **Mechanical Characteristics**

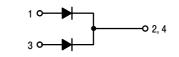
- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Maximum for 10 sec

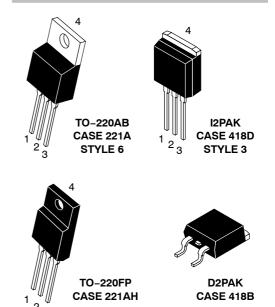


#### **ON Semiconductor®**

http://onsemi.com

#### **PIN CONNECTIONS**





#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

1

#### MAXIMUM RATINGS

| Rating   |                         | Symbol   | Value       | Unit |
|--|-------------------------|--|-------------|------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage                     |                         | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | 100         | V    |
| Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 130°C)  | Per device<br>Per diode | I <sub>F(AV)</sub>                                     | 20<br>10    | A    |
| Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz, $T_C$ = 125°C)                         | Per device<br>Per diode | I <sub>FRM</sub>                                       | 40<br>20    | A    |
| Nonrepetitive Peak Surge Current<br>(Surge applied at rated load conditions halfwave, single phase, 60 Hz) |                         | I <sub>FSM</sub>                                       | 150         | A    |
| Operating Junction Temperature   |                         | TJ   | -40 to +150 | °C   |
| Storage Temperature  |                         | T <sub>stg</sub>                                       | -40 to +150 | °C   |
| Voltage Rate of Change (Rated V <sub>R</sub> )   |                         | dv/dt  | 10,000      | V/μs |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

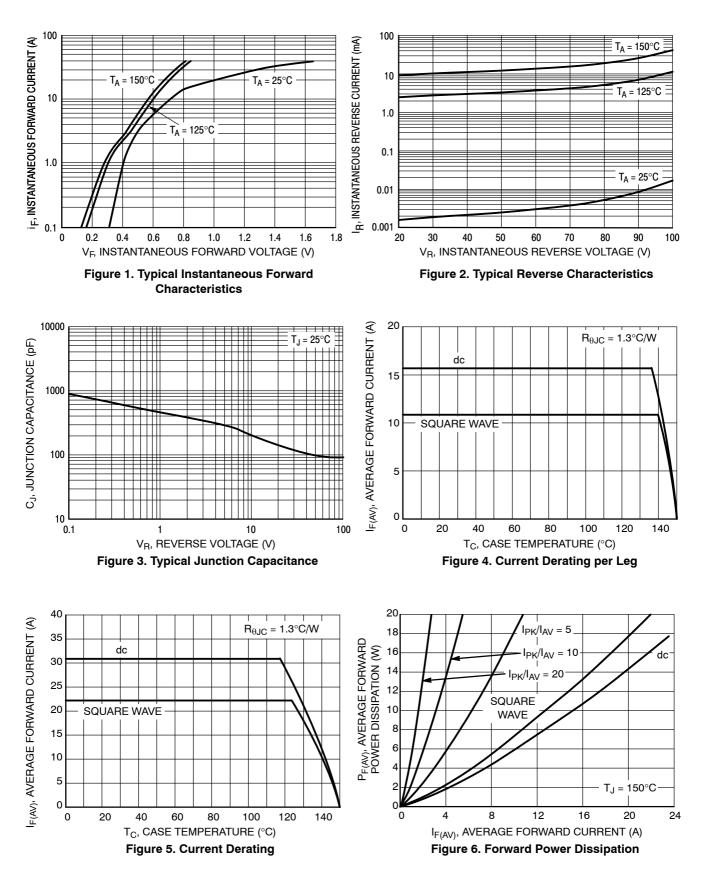
#### THERMAL CHARACTERISTICS

| Rating  | Symbol                         | NTST20U100CTG,<br>NTSB20U100CT-1G | NTSB20U100CTG | NTSJ20U100CTG | Unit         |
|---|--------------------------------|-----------------------------------|---------------|---------------|--------------|
| Maximum Thermal Resistance per Diode<br>Junction-to-Case<br>Junction-to-Ambient | $R_{	heta JC} \\ R_{	heta JA}$ | 2.5<br>70                         | 1.24<br>46.7  | 4.20<br>105   | °C/W<br>°C/W |

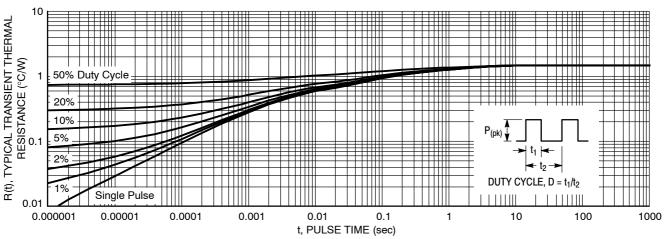
#### ELECTRICAL CHARACTERISTICS (Per Leg unless otherwise noted)

| Rating  | Symbol         | Тур          | Мах       | Unit     |
|---|----------------|--------------|-----------|----------|
| Maximum Instantaneous Forward Voltage (Note 1)  | ٧ <sub>F</sub> |              |           | V        |
| $(I_F = 5 \text{ A}, T_J = 25^{\circ}\text{C})$<br>$(I_F = 10 \text{ A}, T_J = 25^{\circ}\text{C})$   |                | 0.55<br>0.65 | 0.79      |          |
| $(I_F = 5 \text{ A}, T_J = 125^{\circ}\text{C})$<br>$(I_F = 10 \text{ A}, T_J = 125^{\circ}\text{C})$ |                | 0.50<br>0.58 | _<br>0.68 |          |
|   | I <sub>R</sub> | 17<br>5.3    |           | μA<br>mA |
| (Rated dc Voltage, $T_J = 25^{\circ}C$ )<br>(Rated dc Voltage, $T_J = 125^{\circ}C$ )                 |                | _<br>12      | 800<br>25 | μA<br>mA |

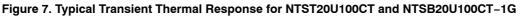
1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\,\leq\,$  2.0%

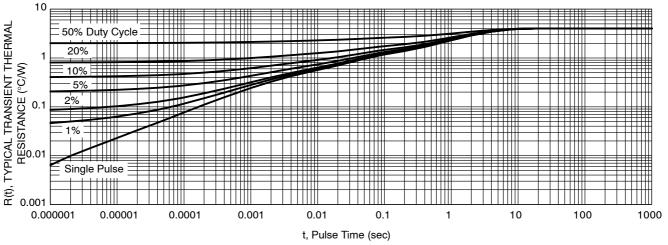


#### **TYPICAL CHARACTERISITICS**

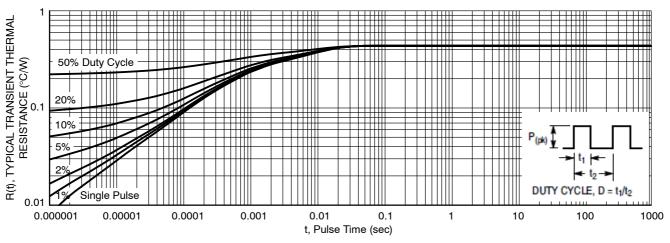


#### **TYPICAL CHARACTERISITICS**











#### **ORDERING INFORMATION**

| Device          | Package                         | Shipping          |  |
|-----------------|---------------------------------|-------------------|--|
| NTST20U100CTG   | TO-220AB<br>(Pb-Free)           | 50 Units / Rail   |  |
| NTSB20U100CT-1G | l <sup>2</sup> PAK<br>(Pb–Free) | 50 Units / Rail   |  |
| NTSJ20U100CTG   | TO-220FP<br>(Halide-Free)       | 50 Units / Rail   |  |
| NTSB20U100CTG   | D <sup>2</sup> PAK<br>(Pb-Free) | 50 Units / Rail   |  |
| NTSB20U100CTT4G | D <sup>2</sup> PAK<br>(Pb-Free) | 800 / Tape & Reel |  |

#### AYWW AYWW TS20U10CG AYWW AYWW TS20U10CG TS20U10Cx TS20U10CG AKA AKA AKA AKA I<sup>2</sup>PAK TO-220FP D<sup>2</sup>PAK TO-220AB

| Α | = Assembly Location |
|---|---------------------|

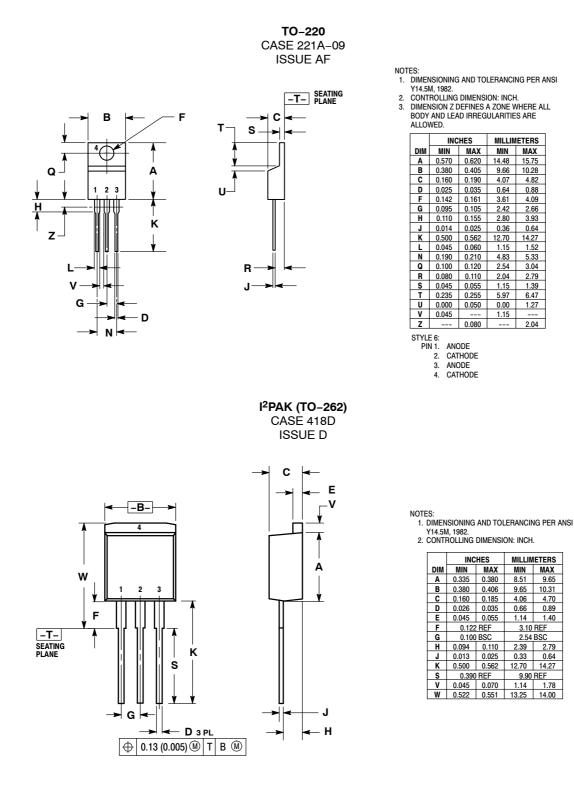
| / <b>\</b> | - / 000011 |
|------------|------------|
| Y          | = Year     |

ww = Work Week

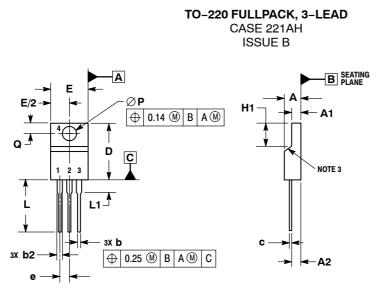
- AKA = Polarity Designator
- х = G or H
- G = Pb-Free Package
- Н = Halide-Free Package

**MARKING DIAGRAMS** 

#### PACKAGE DIMENSIONS



#### PACKAGE DIMENSIONS



NOTES:

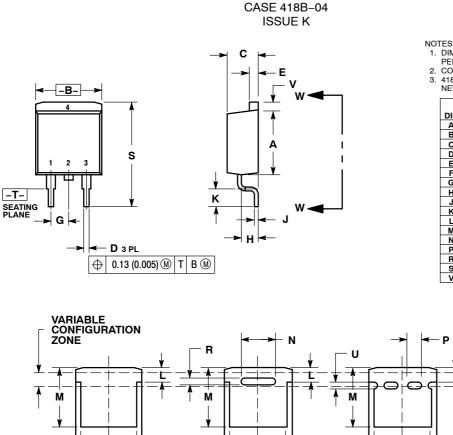
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. CONTOUL UNCONTROLLED IN THIS AREA. 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH AND GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE TO BE MEASURED AT OUTERMOST EXTREME OF THE PLASTIC BODY. 5. DIMENSION b2 DOES NOT INCLUDE DAMBAR PROTRUSION. LEAD WIDTH INCLUDEID AMBAR PROTRUSION. LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 2.00.

|     | MILLIMETERS |       |  |  |
|-----|-------------|-------|--|--|
| DIM | MIN MAX     |       |  |  |
| Α   | 4.30        | 4.70  |  |  |
| A1  | 2.50        | 2.90  |  |  |
| A2  | 2.50        | 2.70  |  |  |
| b   | 0.54        | 0.84  |  |  |
| b2  | 1.10        | 1.40  |  |  |
| C   | 0.49        | 0.79  |  |  |
| D   | 14.70       | 15.30 |  |  |
| Е   | 9.70        | 10.30 |  |  |
| е   | 2.54        | BSC   |  |  |
| H1  | 6.70        | 7.10  |  |  |
| L   | 12.70       | 14.73 |  |  |
| L1  |             | 2.80  |  |  |
| Ρ   | 3.00        | 3.40  |  |  |
| Q   | 2.80        | 3.20  |  |  |

#### PACKAGE DIMENSIONS

D<sup>2</sup>PAK 3

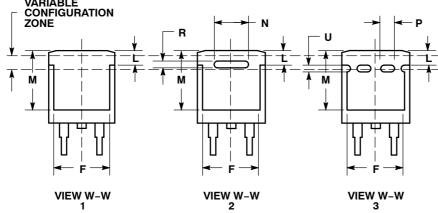


1. DIMENSIONING AND TOLERANCING

PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

|     | INCHES    |       | MILLIN   | IETERS |
|-----|-----------|-------|----------|--------|
| DIM | MIN       | MAX   | MIN      | MAX    |
| Α   | 0.340     | 0.380 | 8.64     | 9.65   |
| В   | 0.380     | 0.405 | 9.65     | 10.29  |
| С   | 0.160     | 0.190 | 4.06     | 4.83   |
| D   | 0.020     | 0.035 | 0.51     | 0.89   |
| Е   | 0.045     | 0.055 | 1.14     | 1.40   |
| F   | 0.310     | 0.350 | 7.87     | 8.89   |
| G   | 0.100     | BSC   | 2.54 BSC |        |
| Н   | 0.080     | 0.110 | 2.03     | 2.79   |
| J   | 0.018     | 0.025 | 0.46     | 0.64   |
| К   | 0.090     | 0.110 | 2.29     | 2.79   |
| L   | 0.052     | 0.072 | 1.32     | 1.83   |
| М   | 0.280     | 0.320 | 7.11     | 8.13   |
| Ν   | 0.197 REF |       | 5.00 REF |        |
| Р   | 0.079 REF |       | 2.00 REF |        |
| R   | 0.039 REF |       | 0.99 REF |        |
| S   | 0.575     | 0.625 | 14.60    | 15.88  |
| v   | 0.045     | 0.055 | 1.14     | 1.40   |



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